Onsemi

MOSFET – Single, **N-Channel, POWERTRENCH®**

30 V, 11 A, 13 m Ω

FDMA7630

Description

This Device has been Designed To Provide Maximum Efficiency and Thermal Performance for synchronous buck converters. The low R_{DS(on)} and gate charge provide excellent switching performance.

Features

- Max $R_{DS(on)} = 13 \text{ m}\Omega$ at $V_{GS} = 10 \text{ V}$, $I_D = 11 \text{ A}$
- Max $R_{DS(on)} = 20 \text{ m}\Omega$ at $V_{GS} = 4.5 \text{ V}$, $I_D = 9 \text{ A}$
- Low Profile 0.8 mm Maximum in the New Package MicroFET[™] 2x2 mm
- Free from halogenated compounds and antimony oxides
- These Devices is Pb-Free, Halide Free and is RoHS Compliant

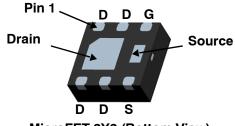
Typical Applications

DC–DC Buck Converters

ABSOLUTE MAXIMUM RATINGS T_A = 25°C unless otherwise noted

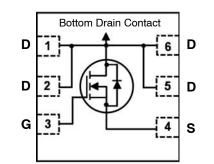
X					
Symbol	Parameter	Value	Unit		
V _{DSS}	Drain to Source Voltage	30	V		
V _{GSS}	Gate to Source Voltage	±20	V		
ID	Drain Current – Continuous T _A = 25°C (Note 1a) – Pulsed	11 24	A		
P _D	P_D Power Dissipation $T_A = 25^{\circ}C$ (Note 1)		w		
Power Dissipation $T_A = 25^{\circ}C$ (No		0.9	vv		
T _J , T _{stg} Operating and Storage Junction Temperature Range		-55 to +150	°C		

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.



MicroFET 2X2 (Bottom View)

WDFN6 2X2, 0.65P CASE 511CZ



MARKING DIAGRAM



&Z = Assembly Plant Code &2

= Date Code (Year & Week)

- &K = Lot Traceability Code
- 630 = Specific Device Code

ORDERING INFORMATION

Device	Package	Shipping [†]
FDMA7630	WDFN-6 (Pb-Free)	3000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

FDMA7630

THERMAL CHARACTERISTICS

Q_{rr}

Reverse Recovery Charge

Symbol	Parameter	Value	Unit	
R_{\thetaJA}	Thermal Resistance, Junction to Ambient (Note 1a)	52	°C/W	
R _{θJA}	Thermal Resistance, Junction to Ambient (Note 1b) 145		°C/W	

ELECTRICAL CHARACTERISTICS $T_J = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
Off Charac	cteristics	-				
BV _{DSS}	Drain to Source Breakdown Voltage	$I_D = 250 \ \mu A, \ V_{GS} = 0 \ V$	30	-	-	V
$\frac{\Delta \text{BV}_{\text{DSS}}}{\Delta \text{T}_{\text{J}}}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, Referenced to 25° C	-	15	-	mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 24 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	1	μΑ
I _{GSS}	Gate to Source Leakage Current	V _{GS} =+/-20 V, V _{DS} = 0 V	-	-	100	nA
On Charac	cteristics	-				
V _{GS(th)}	Gate to Source Threshold Voltage	V_{GS} = V_{DS} , I_D = 250 μ A	1.0	2.0	3.0	V
$\frac{\Delta V_{\text{GS(th)}}}{\Delta T_{\text{J}}}$	Gate to Source Threshold Voltage Temperature Coefficient	I_D = 250 µA, Referenced to 25°C	-	-6	-	mV/°C
R _{DS(on)}	Static Drain-Source On-Resistance	$ \begin{array}{l} V_{GS} = 10 \; V, \; I_D = 11 \; A \\ V_{GS} = 4.5 \; V, \; I_D = 9 \; A, \\ V_{GS} = 10 \; V, \; I_D = 11 \; A, \; T_J = 125^\circ C \end{array} $	- - -	10 14 14	13 20 18	mΩ
9fs	Forward Transconductance	V _{DS} = 5 V, I _D = 11 A		36	-	S
Dynamic (Characteristics					
C _{iss}	Input Capacitance	V_{DS} = 15 V, V_{GS} = 0 V, f = 1.0 MHz	-	1020	1360	pF
C _{oss}	Output Capacitance	7	-	315	415	pF
C _{rss}	Reverse Transfer Capacitance		-	35	55	pF
Rg	Gate Resistance		-	1.7	-	Ω
Switching	Characteristics (Note 2)					
t _{d(on)}	Turn-On Delay Time	$V_{DD} = 15 \text{ V}, \text{ I}_{D} = 11 \text{ A},$	-	8	15	ns
t _r	Rise Time	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$	-	3	10	ns
t _{d(off)}	Turn-Off Delay Time	7	-	19	34	ns
t _f	Fall Time		-	3	10	ns
Qg	Total Gate Charge	$V_{GS} = 0 V \text{ to } 10 V$ $V_{DD} = 15 V$, $I_D = 11 A$	-	16	22	nC
		$V_{GS} = 0 V \text{ to } 4.5 V,$ $V_{DD} = 15 V, I_D = 11 A$	-	8	10	nC
Q _{gs}	Gate to Source Gate Charge	$V_{DD} = 15 V,$	-	3.0	-	nC
Q _{gd}	Gate to Drain "Miller" Charge	I _D = 11 A	-	2.2	-	nC
Drain-Sou	urce Diode Characteristics and Maximum	Ratings				
۱ _S	Maximum Continuous Drain-Source Diode Forward Current		-	-	2	А
V_{SD}	Source to Drain Diode Forward Voltage	V _{GS} = 0 V, I _S = 2 A (Note 2)	-	0.8	1.2	V
t _{rr}	Reverse Recovery Time	I _F = 11 A, di/dt = 100 A/μs	-	21	33	ns
Drain-Sou I _S V _{SD}	arce Diode Characteristics and Maximum Maximum Continuous Drain–Source Diode Source to Drain Diode Forward Voltage	Ratings Θ Forward Current $V_{GS} = 0 \text{ V}, I_S = 2 \text{ A (Note 2)}$	-	0	-	- 2 .8 1.2

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

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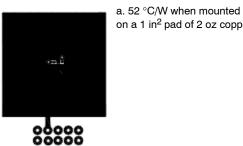
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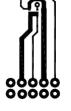
nC

NOTES:

1. $R_{\theta JA}$ is determined with the device mounted on a 1 in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. $R_{\theta JC}$ is guaranteed by design while $R_{\theta CA}$ is determined by the user's board design.



on a 1 in² pad of 2 oz copper.

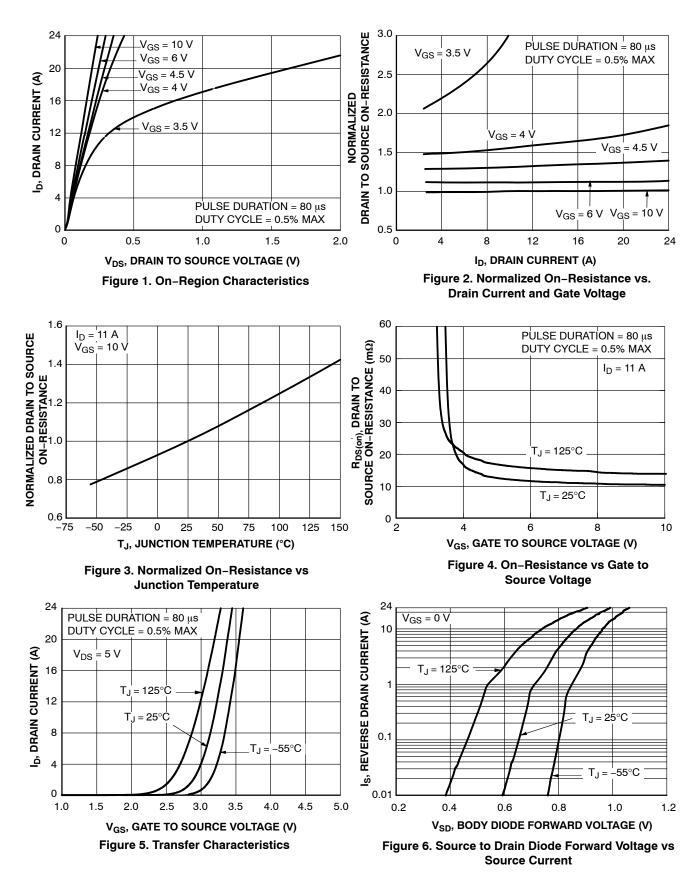


b. 145 °C/W when mounted on a minimum pad of 2 oz copper.

2. Pulse Test: Pulse Width \leq 300 $\mu s,$ Duty Cycle \leq 2.0%

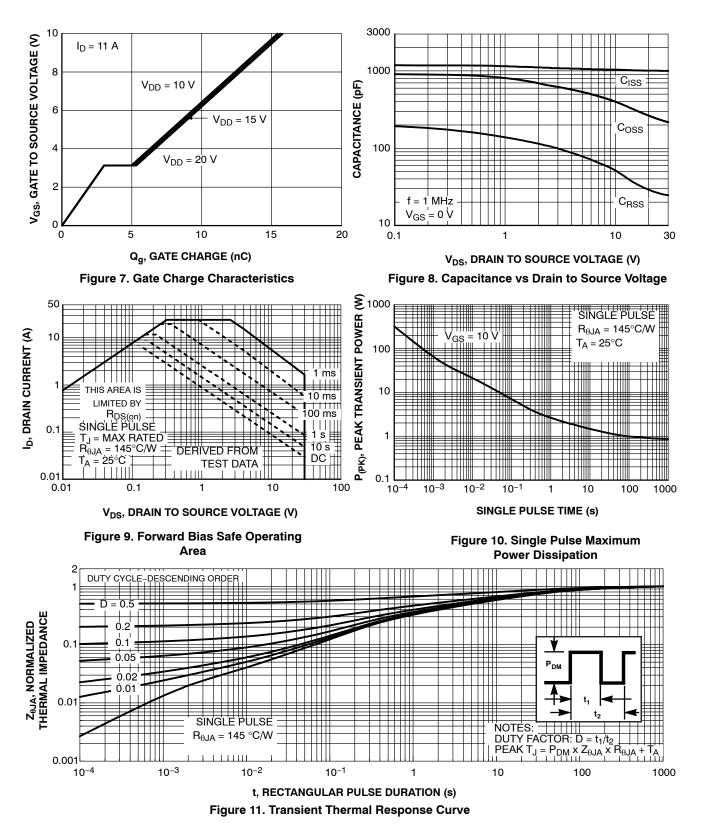
FDMA7630

TYPICAL CHARACTERISTICS



FDMA7630

TYPICAL CHARACTERISTICS (CONTINUED)

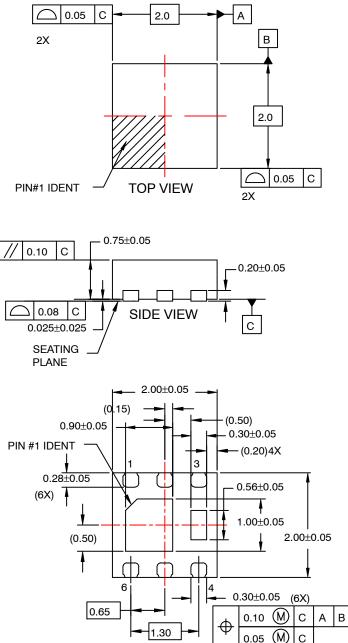


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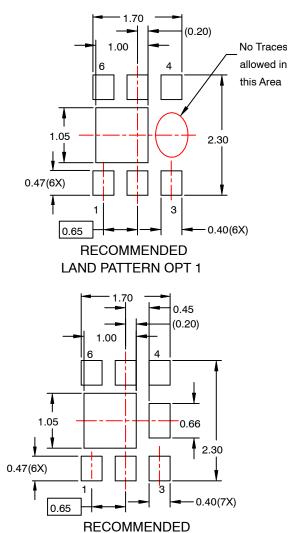
WDFN6 2x2, 0.65P CASE 511CZ ISSUE O

DATE 31 JUL 2016



BOTTOM VIEW

(M) 0.05 С



NOTES:

A. PACKAGE DOES NOT FULLY CONFORM TO JEDEC MO-229 REGISTRATION

LAND PATTERN OPT 2

- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 2009.
- D. LAND PATTERN RECOMMENDATION IS EXISTING INDUSTRY LAND PATTERN.

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DESCRIPTION:	WDFN6 2X2, 0.65P		PAGE 1 OF 1	

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